

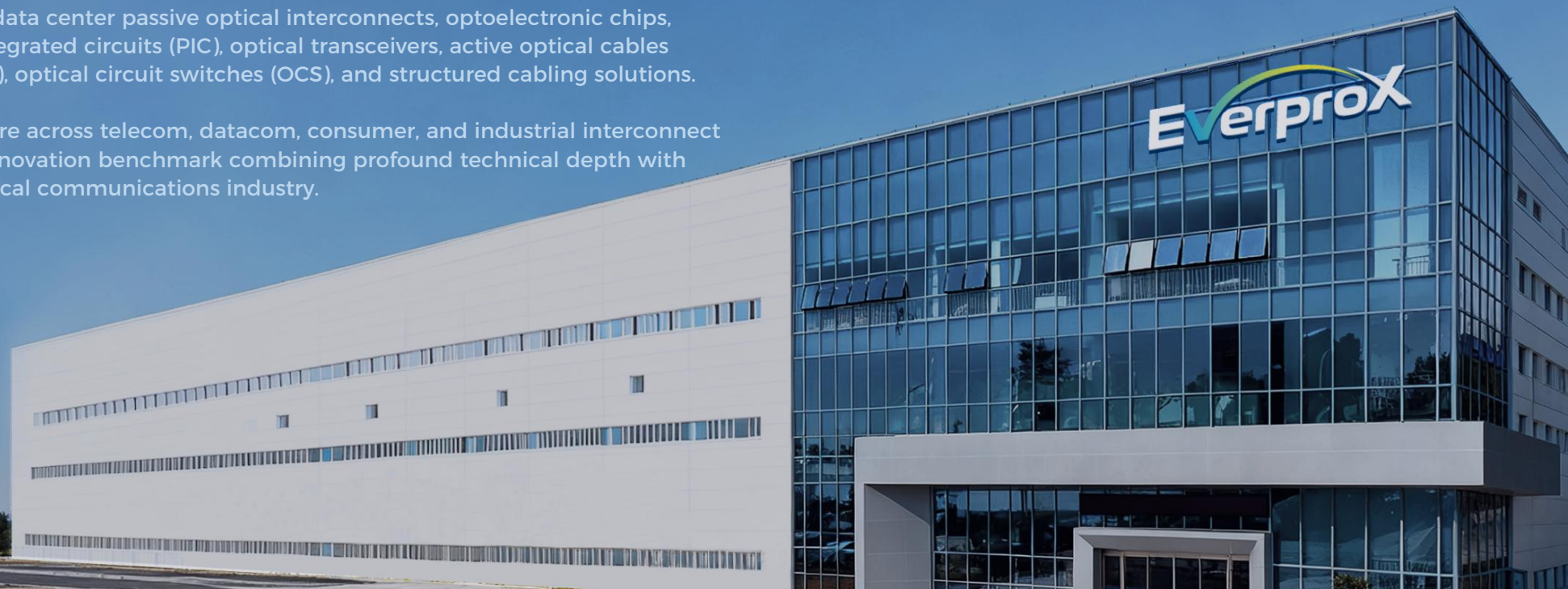


EverProX Technologies Co., Ltd.

EverProX | Provider of comprehensive optical and electrical interconnection solutions

Our comprehensive portfolio spans data center passive optical interconnects, optoelectronic chips, active optical modules, photonic integrated circuits (PIC), optical transceivers, active optical cables (AOC), copper cables (DAC/ACC/AEC), optical circuit switches (OCS), and structured cabling solutions.

Holding a leading global market share across telecom, datacom, consumer, and industrial interconnect sectors, the company serves as an innovation benchmark combining profound technical depth with extensive industrial reach in the optical communications industry.



Telecommunications

Leading the global market share in PLC optical splitters, DWDM devices, and 10G PON optical modules

Data Communication

A core supplier for North American hyperscalers

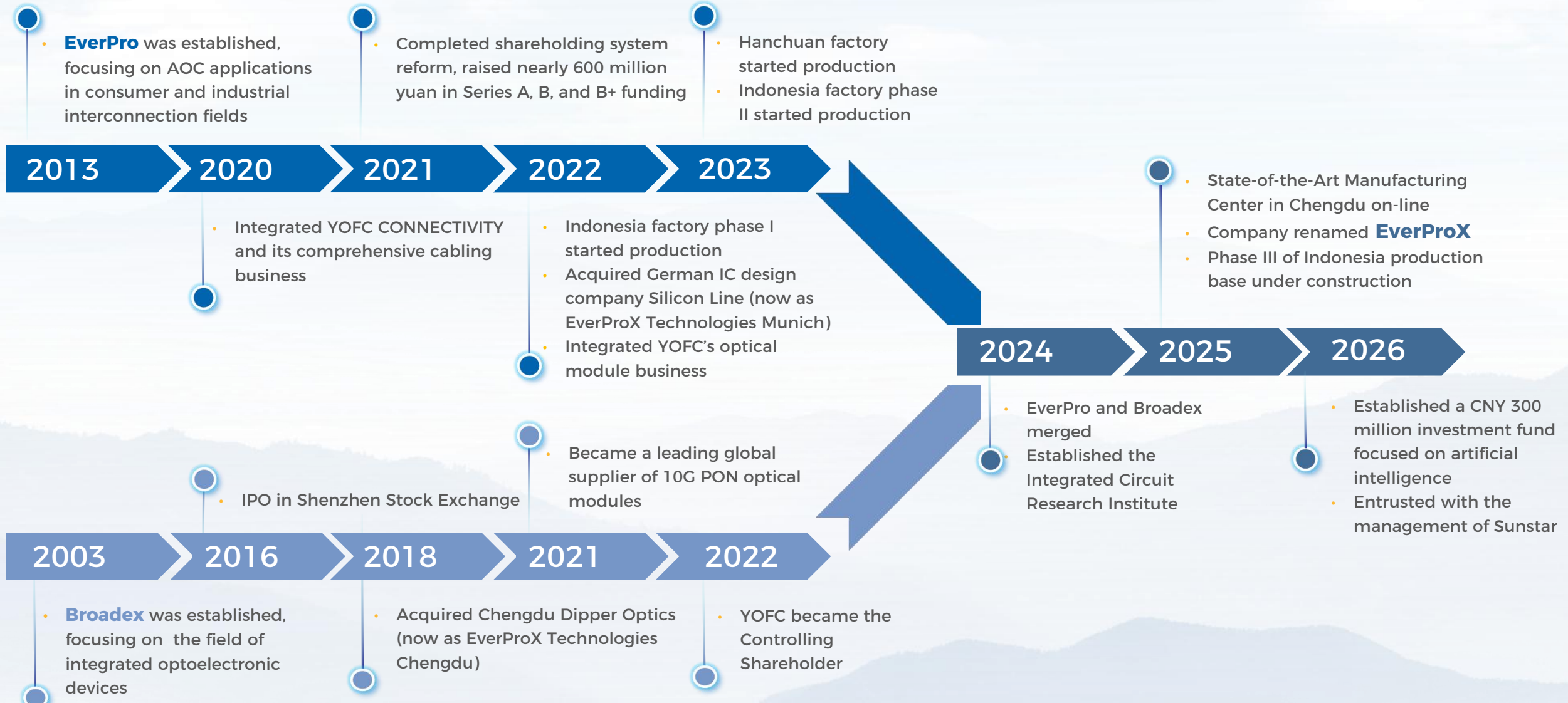
Holds a leading market share in passive optical products for the data centers and high-performance computing systems in the China market

Consumer Electronics and Industrial Interconnection

Leading the global shipment volume in consumer AOC

Leading the global market share in low-power optoelectronic transceiver chips

History & Milestones



EverProX in Global



4+1

4 domestic R&D centers
1 overseas R&D center

3+1

3 domestic production bases
1 overseas production base

16

National/Regional
Markets

1300+

Global staff

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Driven by Technological Innovation

1.1+
Billion

Cumulative R&D Investment

Ultra-Low Power 2Gbps
MIPI DPHY SerDes IC

2011

Super TT USB 3.0 to 2.0

Ultra-Low Power
12Gbps VCSEL Driver &
TIA (4 Channel)

2012



Ultra-Low Power 4Gbps
MIPI DPHY Serializer/De-
serializer

2013

Ultra-Low Power USB 3.2
Gen 1 (5Gbps) Transceiver
with VCSEL Driver & TIA

Ultra-Low Power HDMI 2.0
VCSEL Driver & TIA (4
Channel)

2014



USB 3.1/HDMI 2.1/DP
1.4 VCSEL Driver &
Receiver with LA, TIA

2016



Low Speed Signal
Transceiver
(HPD/12C/AUX/GPIO)

2018

Ultra-Low Power 16Gbps
VCSEL Driver & TIA (1/4
Channel)

Ultra-Low Power HDMI 2.1
VCSEL Driver & TIA (4
Channel)

2019



R&D
Team

Staff
259

- Cover full-process chain including chips, devices, modules, cables, packaging and automation
- Member of Ethernet, PCI-SIG, HDMI, USB-IF, VESA, MIPI, contribute to the development of international standard
- Deepen collaboration with leading universities like HUST and build joint practice bases to foster the next generation of industry talent

Achievements

Patents
270

Awards

- "China Chip" New Star Product Award
- Hubei Province High-Value Patent Competition Gold Award

Integrated Circuit
Research Institute

Staff
50+

Experience 20+ years
(With backgrounds at top-tier global
semiconductor companies)

Education
95% hold a Master's
degree or higher

Nationality
20+

Innovative design
The world's only ultra-low power MIPI SerDes chip for VR
application

2020

Ultra-Low Power USB 3.2
Gen 2 Transceiver with
VCSEL Driver & TIA

Ultra-Low Power DP 1.4
VCSEL Driver & TIA (4
Channel)

2021



USB 3.1/HDMI 2.1/DP
1.4 VCSEL Driver &
Receiver with TIA &
CDR (6 Channel)

2023



Ultra-Low Power 10Gbps
MIPI DPHY SerDes IC
with VCSEL Driver & TIA

2024



4 Channel 20Gbps Redriver
Chip for Active Cable
USB4/TBT3/DP 2.0

2025



Ultra-Low Power 10Gbps
MIPI DPHY SerDes IC for
Stereo Camera and with
Reserve Channel

2026

USB4/TBT3/DP 2.0 VCSEL
Driver & Receiver with TIA
& CDR (8 Channel)

Ultra-Low Power
24Gbps MIPI CPHY
SerDes IC with VCSEL
Driver & TIA

Global Production Ensures Efficient Delivery



Chengdu

527,431ft²

- PON optical modules
- DAC/ACC/AEC
- Consumer AOC

Hanchuan

430,556ft²

- Optical cables
- Passive optical jumper cables
- Active optical modules
- Consumer AOC

Jiaxing

161,459ft²

- Integrated optoelectronic devices

Indonesia

509,132ft²
(Phase I -III)

- Integrated optoelectronic devices
- Active optical modules
- PON optical modules
- Consumer AOC
- Optical cables
- Passive optical jumper cables



Quality Management & International
Standards Certified

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Business Focus

DCP



Customized patch cord solutions are provided, focusing on hyperscalers, as well as AI cluster scenarios within the cloud computing and data center sectors.

PIC



Providing efficient and reliable passive optical layer solutions, including PLC splitters for Fiber-to-the-Home and DWDM/AWG devices for backbone networks.

OCS



Powered by a MEMS-chip-based optical design and packaging platform, an automated fiber threading and coupling platform, an AI-algorithm-driven actuation and calibration platform, we deliver high-performance OCS systems to customers worldwide.

CS



With a focus on data centers and smart buildings, we provide customers with efficient, reliable, and end-to-end structured cabling products and solutions.

Eight Core Product Lines

Datacom
& Telecom
Passive

Datacom
& Telecom
Active

Photonic
Integrated
Circuit

Integrated
Circuit

Optical
Circuit
Switch

Passive
Optical
Network

Cabling
& System

Consumer
& Industrial
Active Cable

DTA



Providing core connectivity solutions for data centers that are high-speed, low-power, and highly reliable. The product portfolio encompasses optical transceivers, AOC, DAC/ACC/AEC.

IC



Leveraging high-performance SerDes, ultra-low-power PHY chips, and proven copper and optical interconnect solutions, we deliver one-stop solutions for edge AI, XR, medical imaging, machine vision, and beyond.

PON



Providing highly integrated, high-bandwidth and cost-effective FTTX solutions, with a full product portfolio covering 50G/10G PON OLT/ONU components and optical modules.

CIA



Leveraging self-developed chips and proprietary BendRobust™ fiber technology, we deliver high-speed data transmission one-stop solutions and customized products for consumer and industrial interconnects.



2026

Thanks !